

FFAF40U60DN

Features

- High voltage and high reliability
- High speed switching
- Low forward voltage

Applications

- General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- Power switching circuits



TO-3PF

1 2

ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	40	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	240	А
T _{J,} T _{STG}	Operating Junction and StorageTemperature	- 65 to +150	°C

Thermal Characteristics

Symbol	Parameter	Value	Units	
R ₀ JC	Maximum Thermal Resistance, Junction to Case	0.7	°C/W	

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	Maximum Instantaneous Forward Voltage $I_F = 40A$ $I_F = 40A$	T _C = 25 °C T _C = 100 °C		V V	2.1 1.9	V
RM *	Maximum Instantaneous Reverse Current @ rated V _R	T _C = 25 °C T _C = 100 °C	-		20 200	μΑ
in Qn Qn	Maximum Reverse Recovery Time Maximum Reverse Recovery Current Maximum Reverse Recovery Charge (I _F =40A, di/dt = 200A/μs)		- - -	- - -	110 10 550	ns A nC
W _{AVL}	Avalanche Energy		1.0	-	-	mJ

^{*} Pulse Test: Pulse Width=300μs, Duty Cycle=2%

Typical Characteristics

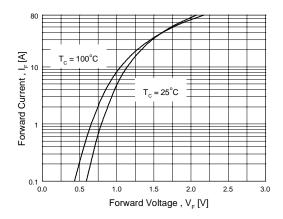


Figure 1. Typical Forward Voltage Drop vs. Forward Current

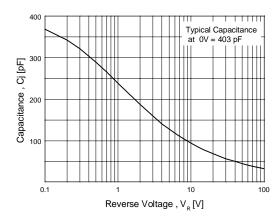


Figure 3. Typical Junction Capacitance

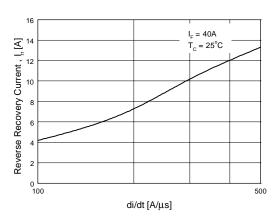


Figure 5. Typical Reverse Recovery Current vs. di/dt

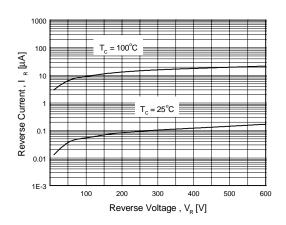


Figure 2. Typical Reverse Current vs. Reverse Voltage

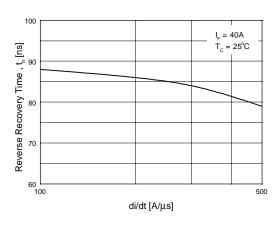


Figure 4. Typical Reverse Recovery Time vs. di/dt

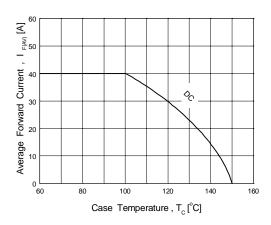
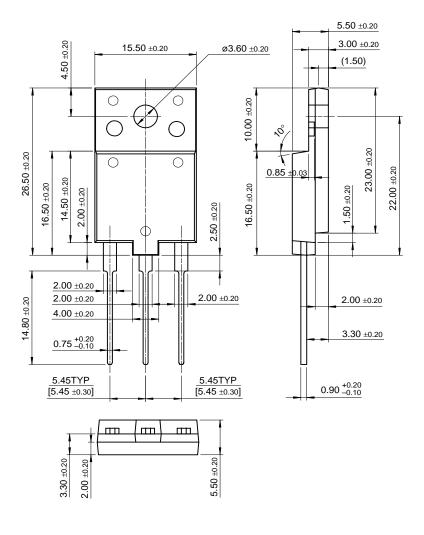


Figure 6. Forward Current Derating Curve

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Package Dimensions

TO-3PF



Dimensions in Millimeters

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